## APPENDIX B TBD Resolution Matrix

TBD Number	Resolution
TBD1	The Space Station document that defines the HRDL packet or bitstream data is being updated by the program. When the correct document has been identified, it will be placed in the specification.
TBD2	Will define the Attached Payload Data and Resource connectors at CDR. Awaiting further definition by the Program.
TBD3	In the process of locating the appropriate UOF specification that defines Payload Commanding Data and Telemetry Data formats.
TBD4	In the process of locating the appropriate PDSS specification that defines the Payload Commanding Data and Telemetry Data formats.
TBD5	Cooling resources for PRCU equipment will be quantified after completion of the Facilitization Trade Study.
TBD6	PRCU Physical characteristics will be quantified after completion of the Facilitization Trade Study.
TBD7	Environmental conditions will be quantified after completion of the Facilitization Trade Study.
TBD8	Transportability will be quantified after completion of the Facilitization Trade Study when the decision is made on how the PRCU will be packaged and delivered (Trailer vs. User Facility).
TBD9	The Electromagnetic Radiation requirements will remain TBD until CDR.
TBD10	Installation/Removal requirements will remain TBD until the completion of the Facilitization Trade Study.
TBD11	Requirement for user facilities and facility equipment will be quantified after completion of the Facilitization Trade Study.
TBD12	Personnel & Training will remain TBD until CDR when the maintenance documentation is completed.
TBD13	Voltage increments for Interface B will remain TBD until the number is baselined in SSP-52000 the Pressurized Payload IDD.
TBD14	Voltage Increments for Interface C will remain TBD until the number is baselined in

## APPENDIX B TBD Resolution Matrix

TBD Number	Resolution
	SSP-52000, the Pressurized Payload IDD.
TBD15	Session analysis tools will be TBD until CDR
TBD16	The Preparation for Delivery section will be quantified after completion of the Facilitization Trade Study.